

DMTH10H2M5STLWQ

100V 175°C N-CHANNEL ENHANCEMENT MODE MOSFET POWERDI1012-8 (TOLL)

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D T _C = +25°C
100V	2.5mΩ @ V _{GS} = 10V	215A

Features

- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- High Conversion Efficiency
 - Low RDS(ON) Minimizes On State Losses
- Wettable Flank for Improved Optical Inspection
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DMTH10H2M5STLWQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/guality/product-definitions/

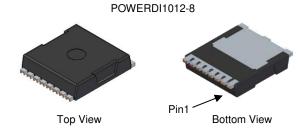
Description and Applications

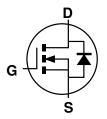
This MOSFET is designed to meet the stringent requirements of automotive applications. It is qualified to AEC-Q101, supported by a PPAP, and is ideal for use in:

- Motor Control
- DC-DC Converters
- Power Management

Mechanical Data

- Case: POWERDI®1012-8 (TOLL)
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.388 grams (Approximate)





Internal Schematic

Ordering Information (Note 4)

-			
	Part Number	Case	Packaging
	DMTH10H2M5STLWQ-13	POWERDI1012-8	1500/Tape & Reel

Notes: 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.

- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



H= Manufacturer's Marking
 TH10H2M5STL = Product Type Marking Code
 YYWW = Date Code Marking
 YY = Last Two Digits of Year (ex: 21 = 2021)
 WW = Week Code (01 to 53)



Maximum Ratings (@ $T_A = +25$ °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Drain-Source Voltage	VDSS	100	V
Gate-Source Voltage	V _{GSS}	±20	V
Continuous Drain Current (Note 6) VGS = 10V	ID	215 152	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	Ірм	860	Α
Maximum Continuous Body Diode Forward Current (Note 6)	Is	215	Α
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)	lsм	860	Α
Avalanche Current, L = 0.3mH	las	68	Α
Avalanche Energy, L = 0.3mH	Eas	701	mJ

Thermal Characteristics

Characteristic	Symbol	Value	Unit	
Total Power Dissipation (Note 5) T _A = +25°C		P_{D}	5.8	W
Thermal Resistance, Junction to Ambient (Note 5)	Reja	26	°C/W	
Total Power Dissipation (Note 6) T _C = +25°C		PD	230.8	W
Thermal Resistance, Junction to Case (Note 6)		Rejc	0.65	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +175	°C	

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)							
Drain-Source Breakdown Voltage	BV _{DSS}	100	_	_	V	$V_{GS} = 0V$, $I_D = 1mA$	
Zero Gate Voltage Drain Current	IDSS	_	_	1	μΑ	V _{DS} = 80V, V _{GS} = 0V	
Gate-Source Leakage	Igss	_	_	±100	nA	$V_{GS} = \pm 20V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)							
Gate Threshold Voltage	V _{GS(TH)}	2	_	4	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance	RDS(ON)	_	1.68	2.5	mΩ	V _G S = 10V, I _D = 30A	
Diode Forward Voltage	V _{SD}	_	0.8	1.2	V	$V_{GS} = 0V, I_{S} = 30A$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	_	8450	_		V _{DS} = 50V, V _{GS} = 0V f = 1MHz	
Output Capacitance	Coss	_	2430	_	pF		
Reverse Transfer Capacitance	C _{rss}	_	17.7	_			
Gate Resistance	Rg	_	1.0	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge	Qg	_	124.4	_		V 50V L 00A	
Gate-Source Charge	Qgs	_	34	_	nC	V _{DD} = 50V, I _D = 30A, V _{GS} = 10V	
Gate-Drain Charge	Qgd	_	28.3	_			
Turn-On Delay Time	tD(ON)	_	32.7	_		V _{DD} = 50V, V _{GS} = 10V,	
Turn-On Rise Time	tr	_	47	_			
Turn-Off Delay Time	tD(OFF)	_	91.3	_	ns	$I_D = 30A$, $R_G = 4.7\Omega$	
Turn-Off Fall Time	t _F	_	53.9				
Reverse Recovery Time	trr	_	87.6	_	ns	I- 05 A di/dt 100 A /	
Reverse Recovery Charge	Q _{RR}	_	251.8	_	$_{\text{nC}}$ IF = 25A, di/dt = 100A/ μ s		

Notes: 5. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate. 6. Thermal resistance from junction to soldering point (on the exposed drain pad).

^{7.} Short duration pulse test used to minimize self-heating effect.

^{8.} Guaranteed by design. Not subject to product testing.



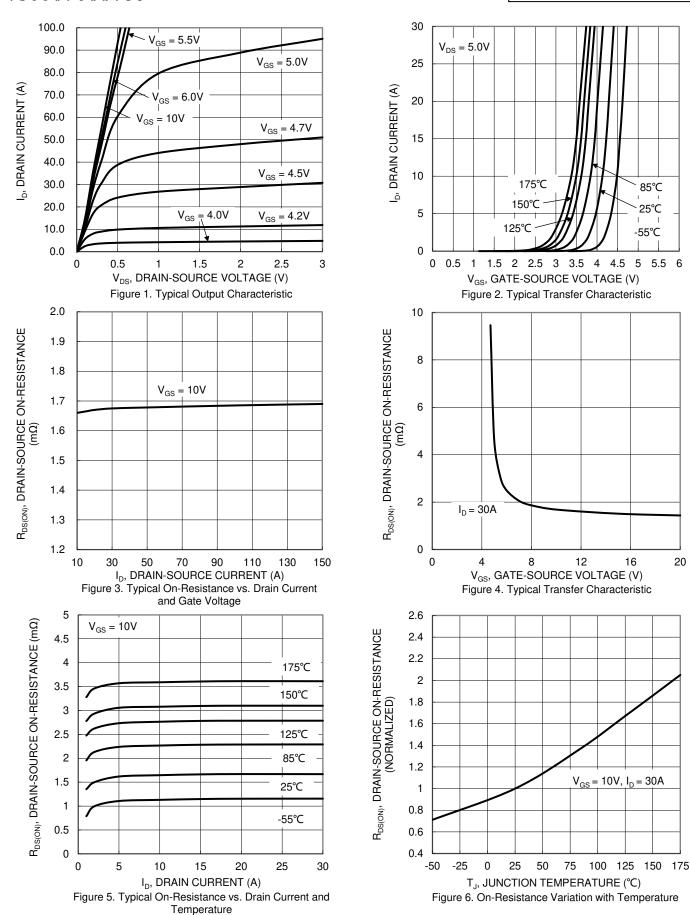
85°C

25°C

-55°C

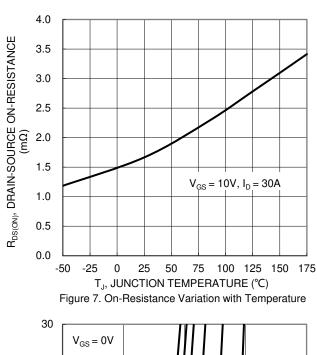
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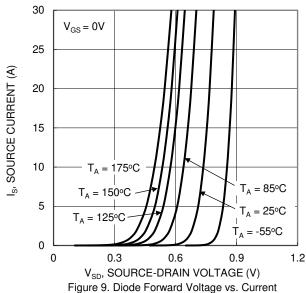












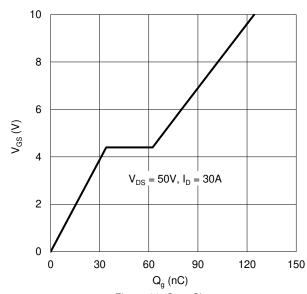
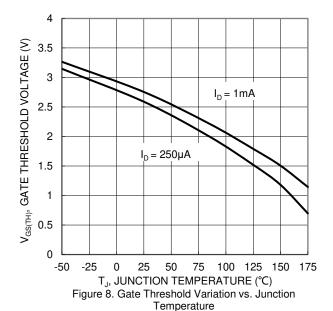
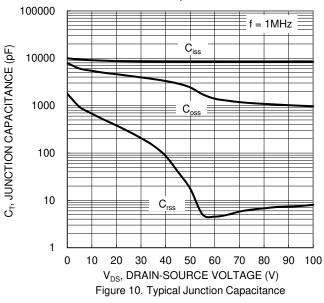
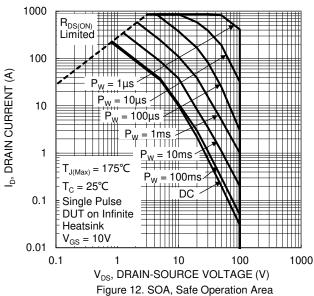


Figure 11. Gate Charge









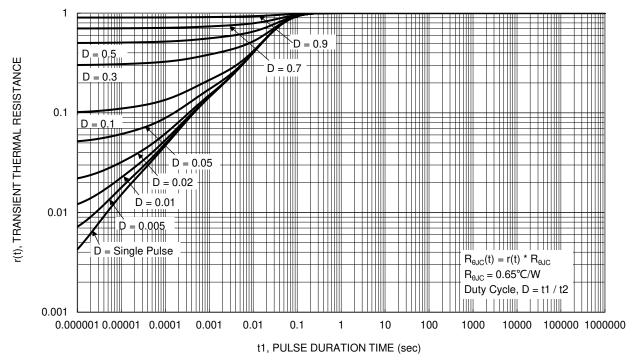


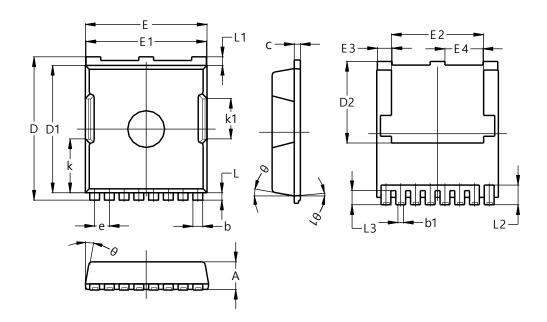
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

POWERDI1012-8

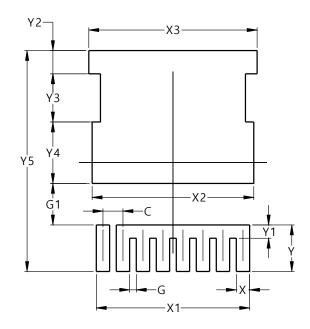


POWERDI1012-8						
Dim	Min	Max	Тур			
Α	2.20	2.40	2.30			
b	0.70	0.90	0.80			
b1	0.42	0.50	0.45			
C D	0.40	0.60	0.50			
	11.48	11.88	11.68			
D1	10.23	10.53	10.38			
D2	6.45	6.85	6.65			
Е	9.70	10.10	9.90			
E1	9.70	9.90	9.80			
E2	7.00	8.00	7.50			
E3	1.10	1.30	1.20			
E4	3.00	3.20	3.10			
е	1.20 BSC					
k	4.39 REF					
k1	3.30 REF					
L	0.50	0.70	0.60			
L1	0.50	0.90	0.70			
L2	1.40	1.80	1.60			
L3	1.00	1.30	1.15			
θ	0∘	15º	10º			
θ1	0₀	10⁰	5º			
All Dimensions in mm						

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

POWERDI1012-8



Dimensions	Value (in mm)			
С	1.200			
G	0.400			
G1	2.500			
X	0.800			
X1	9.200			
X2	9.700			
Х3	10.100			
Υ	2.800			
Y1	0.800			
Y2	1.400			
Y3	2.900			
Y4	3.700			
Y5	13.300			



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